Subsolidus phase equilibria in the PbO-poor part of the TiO₂-PbO-SiO₂ system and its application in low-temperature thick-film dielectrics

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> Version of record: Journal of Materials Research 21 (12), 3210-3214, 2006. http://hdl.handle.net/10.1557/jmr.2006.0396

Abstract

Subsolidus equilibria in the PbO-poor part of the TiO₂–PbO–SiO₂ diagram were studied with the aim of investigating possible applications for low-temperature thick-film dielectrics. The tie lines are between PbTiO₂ and PbSiO₃, and between PbTiO₃ and SiO₂. The results show that the TiO₂, when added to low-temperature softening point glasses, reacts with the PbO from the glass, so forming PbTiO₃. These results were applied to a low-temperature firing dielectric, consisting of a lead-rich PbO–SiO2–B2O₃ glass filled with a TiO₂ powder. The conversion of TiO₂ to the PbTiO₃ crystalline phase was observed above firing temperatures of approximately 600°C. The kinetics of the reaction depends on the particle size of the TiO₂.

Keywords: Dielectric, phase equilibria, scanning electron microscopy, X-ray diffraction

1 Introduction

The standard thick-film technology for applications in electronics and sensors normally makes use of ceramic alumina substrates, which have a good thermal and chemical stability. In this case, conductors, multilayer dielectrics and resistors are screen printed and fired at a standard temperature of 850°C. This processing temperature is, however, not compatible with many potentially useful substrates. For instance, high-strength steel [1], Ti [2] and Al alloys have much better elastic properties than Al₂O₃, and hence are better suited to piezoresistive sensors. Al, Al-Si and Al-SiC composites are promising materials for power electronics due to their good thermal conductivity. Finally, thick films on glass have promising applications in display technology, chemical micro-reactors and biotechnology. These substrates all require processing temperatures limited roughly to the range 500–600°C, due to melting (Al, Al-Si, Al-SiC), excessive oxidation (Ti alloys), degradation of mechanical properties (steels) and softening (glass).

Suitable thick-film dielectrics are needed as insulating layers on metallic substrates as well as for multilayer or overglaze compositions. However, the dielectric layer ought to be densely sintered after first firing, but, upon later firings of conductors and resistors at the same temperature on its surface, it ought not to melt or soften again. These desirable characteristics can be obtained with crystallisable glass, a mixture of glass and ceramics (e.g., Al_2O_3) or a combination of both. In this work we endeavour to investigate the combination of a low-melting, lead-rich glass with a reactive TiO_2 filler. The glass is based on the lead borosilicate system, similar to the glass phase used in thick-film resistors [3] and overglazes. Resistors, which are usually fired around 850° C, have a PbO / SiO_2 molar ratio of about 1 / 2. The overglaze compositions, which have lower firing temperatures in line with our requirements (500– 600° C), are richer in PbO: The PbO / SiO_2 , analysed with an energy-dispersive X-ray analyser (EDS), is roughly 45 mol.% PbO / 55 mol.% SiO_2 . The addition of a reactive TiO_2 filler in these glasses would presumably result in the following reaction during firing:

PbO (from glass) + $TiO_2 >>> PbTiO_3$ (+ glass depleted in PbO)

The above-mentioned reaction will stabilise the dielectric by both increasing the softening point of the glass (by depleting it in PbO) and increasing the crystalline volume fraction by a factor of around 2, as the reduced cell volumes for TiO₂ and PbTiO₃ are 33.9 Å³ (JCPDS 86-4921) and 63.3 Å³ (JCPDS 72-1135), respectively, assuming that the solubility of the TiO₂ in the glass is small.

In this work we first investigate the subsolidus phase equilibria (in air) in the PbO-poor part of the TiO₂–PbO-SiO₂ system. The results would indicate possible interactions between the PbO-SiO₂ glass and the TiO₂. Subsequently, we extend these results to the fabrication and study of a thick-film dielectric comprised of a low-melting PbO-B₂O₃–SiO₂ glass and crystalline TiO₂ powder with two grain sizes.

The binary compound PbTiO₃ in the PbO-TiO₂ system melts congruently at 1285°C. The melting temperatures of the eutectics are 838°C on the PbO side and 1240°C on the TiO₂ side [4]. Four binary compounds, PbSiO₃, Pb₂SiO₄, Pb₃SiO₅ and Pb₄SiO₆, exist in the PbO-SiO₂ system [5]. The eutectic composition on the SiO₂-rich side of the system is at 62% PbO and the eutectic temperature is 739°C. Two more eutectics are formed between PbSiO₃ and Pb₂SiO₄, and between Pb₂SiO₄ and Pb₃SiO₅, with melting temperatures of 714°C and 711°C, respectively. The Pb₄SiO₆ compound melts incongruently at 725°C. No binary compound exists in the SiO₂-TiO₂ system. The eutectic composition on the SiO₂-rich side of the system is at 90% SiO₂ and the eutectic temperature is 1550°C [6].

2 Experimental

2.1 TiO₂–PbO–SiO₂ phase equilibria.

The starting powders were TiO_2 (Fluka, 99 %), PbO (Johnson Matthey, 99.99%), and SiO_2 (Riedel de Haen, 99.9%). The oxides were mixed in isopropyl alcohol, pressed into pellets, and fired up to five times in air at 700° C with intermediate grinding. During firing the pellets were placed on platinum foils. Heating rate was 10K/min and the time at the temperature 18 hours. X-ray analysis of reacted samples indicated completed reactions even (in some cases) after only two firing cycles. However, five "firings" were used to be reasonably sure that the equlibria were obtained. The compositions of the relevant samples in the PbO-poor part of the TiO_2 -PbO-SiO₂ system are shown in Fig. 3. The SiO_2 / PbO molar ratio in the glass phases is marked near the PbSiO₃ compound in the PbO-SiO₂ system.

The fired materials were characterised by X-ray powder diffraction (XRD) analysis using a Philips PW 1710 X-ray diffractometer with Cu K α radiation. XRD spectra were measured from 2 Θ = 20° to 2 Θ = 70° in steps of 0.02°. A JEOL 5800 scanning electron microscope (SEM) equipped with a link ISIS 300 energy-dispersive X-ray analyser (EDS) was used for the overall microstructural and compositional analysis. Samples prepared for the SEM were mounted in epoxy in a cross-sectional orientation and then polished using standard metallographic techniques. Prior to analysis in the SEM, the samples were coated with carbon to provide electrical conductivity and avoid charging effects. The microstructures of the polished samples were studied by back-scattered electron imaging using compositional contrast to distinguish between the phases that differ in density (average atomic number Z).

2.2 Glass-TiO₂ dielectric

The preparation conditions for the PbO-SiO2-B2O3 glass frit are identical to previous work on dielectrics and resistors with low firing temperature [7]. The glass had a nominal starting molar composition of 44.9 PbO + 33.3 SiO₂ + 19.2 B₂O₃ + 2.6 Al₂O₃, with B₂O₃ further depressing the firing temperature [8], and Al₂O₃ inhibiting crystallisation [9]. After the fabrication of the frit, the glass was mixed with two different TiO₂ powders (Aldrich, 99.9%, 5000 nm and Degussa Aeroxide, 99.5%, 21 nm) and a suitable printing vehicle [7] to form thick-film pastes. These pastes were then printed on 96% Al₂O₃ substrates (Kyocera A-476) and fired in a Sierratherm belt furnace. The chosen firing schedules subjected the films to a dwell time of 15 min at the indicated firing temperature, with temperature rise and fall rates of ca. 50 K/min.

The degree of conversion of TiO₂ to PbTiO₃ was assessed by XRD (Siemens D500) and measurements of the areas of the TiO₂ and PbTiO₃ peaks.

3 Results and discussion

3.1 TiO₂-PbO-SiO₂ phase equilibria

The results of the XRD analysis of the relevant samples, fired in air at 700°C, are summarised in Table 1. The nominal compositions of the samples and the phases identified after firing are given.

Table 1. Results of the X-ray diffraction analysis of some compositions in the TiO₂-PbO-SiO₂ system, fired in air at 700°C.

Nominal composition	Phases identified
$TiO_2 + SiO_2$	$TiO_2 + SiO_2$
$TiO_2 + PbO + SiO_2$	PbTiO ₃ + SiO ₂
$TiO_2 + PbO + 2 SiO_2$	PbTiO ₃ + SiO ₂
$TiO_2 + 2 PbO + SiO_2$	PbTiO ₃ + PbSiO ₃
$TiO_2 + 3 PbO + SiO_2$	PbTiO ₃ + PbSiO ₃
$TiO_2 + 2 PbO + 2 SiO_2$	SiO ₂ + PbTiO ₃ + PbSiO ₃
2 TiO ₃ + PbO + SiO ₂	PbTiO ₃ + TiO ₂ + SiO ₂

The microstructures of the materials with the nominal compositions $TiO_2 + PbO + SiO_2$ and $2 TiO_2 + PbO + SiO_2$ are shown in Figs. 1 and 2, respectively. The $TiO_2 + PbO + SiO_2$ sample is a two-phase mixture of SiO_2 (dark phase) and $PbSiO_3$ (light phase), while the $2 TiO_2 + PbO + SiO_2$ sample is a three-phase mixture of TiO_2 (light grey phase), SiO_2 (dark phase) and $PbTiO_3$ (light phase).

Based on the results obtained by XRD and EDS, a subsolidus PbO-poor part of the TiO₂–PbO–SiO₂ diagram, shown in Fig. 3, was constructed. No ternary compound was found. The tie lines are between PbTiO₃ and PbSiO₃, and between PbTiO₃ and SiO₂. The upper, PbO-rich, part of the phase diagram, which was not investigated, is shown with dotted lines. Based on the phase equilibria and the compounds in the PbO-SiO₂ system [5] the tie lines between PbTiO₃ and Pb₂SiO₄, PbTiO₃ and Pb₃SiO₅, and PbTiO₃ and Pb₄SiO₅, were envisaged.

The results therefore indicate that the TiO₂, if added, reacts with the PbO in the low-temperature-melting glass, forming PbTiO₃ and thus decreasing the PbO concentration of the glass phase and increasing its melting temperature.

3.2 Glass-TiO₂ dielectrics

The XRD results for dielectrics consisting of 86% V6 glass + 14% TiO₂ by mass are shown, in Fig. 4, as a function of firing temperature and for both TiO₂ sizes. The composition has a Ti/Pb molar ratio of approximately 0.63 and, as expected from the above results, complete conversion of TiO₂ to PbTiO₃ takes place, with the (kinetically limited) transition occurring between 580°C and 630°C for the nanoscale TiO₂ powder. This temperature range is shifted by approximately 25°C to higher temperatures for the larger powder. The conversion is accompanied by a change of colour, from almost white to yellowish, which is characteristic for PbTiO₃ [10]. The PbO / SiO₂ molar ratio in the initial glass composition is 1.35. After firing and the formation of the PbTiO₃ the PbO / SiO₂ ratio in the glass phase is changed to 0.49. This is schematically depicted in Fig. 5. The composition of 86 wt.% glass and 14 wt.% TiO₂ is shown projected

onto the TiO₂–PbO–SiO₂ phase diagram. The composition is denoted as an open circle. Dotted lines through this composition show the initial PbO / SiO₂ ratio and the ratio after the formation of the PbTiO₃.

These promising results indicate that we can obtain stabilised low-firing dielectrics: the estimated shift in the glass composition, depicted in Fig. 6 [11], entails an increase of approximately 100°C in the glass-transition temperature, and the filler volume fraction is estimated to increase from about 17 to 35%.

However, the first tests to apply this dielectric onto aluminium substrates were not successful, because it tended to spall off due to excessive compressive stresses. This is due to the low thermal coefficient of expansion (TCE) of both phases (the glass and the PbTiO₃) of the resulting dielectric: PbO depletion results in a strong decrease in the TCE of the glass [11], and PbTiO₃ actually has a negative TCE up to its Curie point at 490°C [10]. This makes the dielectric useful for applications involving low-expansion substrates, such as float glass, or probably even 3.3 borosilicate glass. The application on most metallic substrates, however, would need a higher thermal expansion and a slightly lower reaction temperature (550°C would be ideal). This could probably be accomplished by starting with a glass that has a higher lead content, and limiting the amount of reactive TiO₂ filler or the degree of reaction.

4 Conclusions

An extensive study of the lead-poor region of the TiO₂–PbO–SiO₂ system was carried out. The important result is that TiO₂ has a strong affinity for PbO, so forming PbTiO₃. This feature was used in the formulation of a stabilised low-firing thick-film dielectric, comprised of PbO–B₂O₃–SiO₂ (–Al₂O₃) glass frit and a dispersed TiO₂ powder. The latter should be nanoscale in order to improve the reaction kinetics. In such a case the TiO₂ also reacted with the PbO in the glass at around 600°C, forming PbTiO₃ and thus stabilising the dielectric by increasing the filler volume fraction and through depletion in PbO, by increasing the softening point of the glass. Such dielectrics have a low thermal expansion coefficient and are thus very useful on certain substrates, such as glasses.

Although lead-bearing glasses for electronics are still allowed as an exception to the European Union RoHS directive [12], there is a strong trend towards making thick-film materials fully lead-free if possible. Therefore, further work will be focussed on studying and developing similar low-temperature lead-free materials systems and dielectrics.

Acknowledgements

We thank the Slovenian Research Agency for their financial support.

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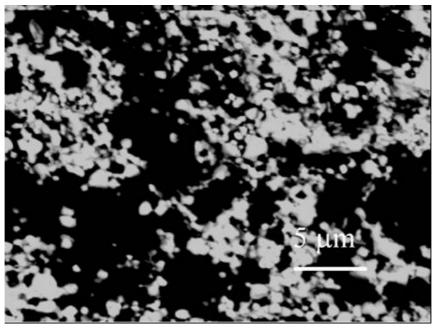


Fig. 1: Microstructure (backscattered electrons) of the sample with the nominal composition TiO₂ + PbO + SiO₂. The material is a two-phase mixture of SiO₂ (dark phase) and PbTiO₃ (light phase).

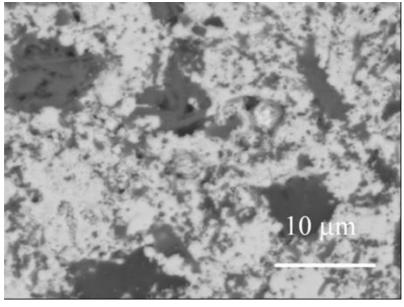


Fig. 2: Microstructure (backscattered electrons) of the sample with the nominal composition 2 TiO₂ + PbO + SiO₂. The material is a three-phase mixture of TiO₂ (light grey phase), SiO₂ (dark phase) and PbTiO₃ (light phase).

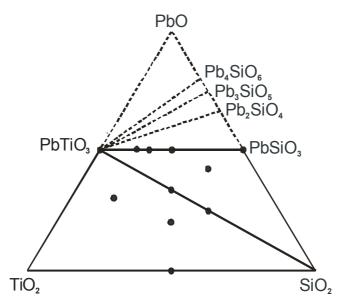


Fig. 3: The proposed subsolidus ternary phase diagram of the PbO-poor part of the TiO_2 - PbO - SiO_2 . The PbO-rich part of phase diagram, which was not investigated, is shown with dotted lines.

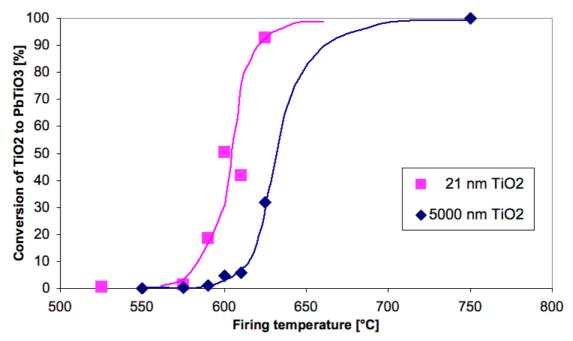


Fig. 4. Degree of conversion of TiO₂ to PbTiO₃, estimated from XRD measurements. The lines are merely a guide to the eye.

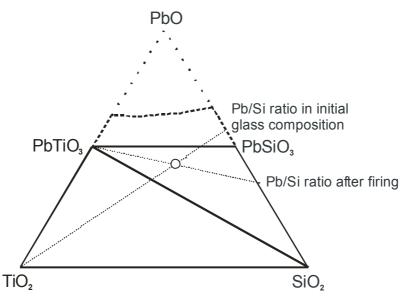


Fig. 5: The composition of 86 wt.% glass and 14 wt.% TiO₂ projected onto the TiO₂- PbO – SiO₂ phase diagram. The molar ratios PbO / SiO₂ in the glass before and after formation of PbTiO₃ are indicated by dotted lines.

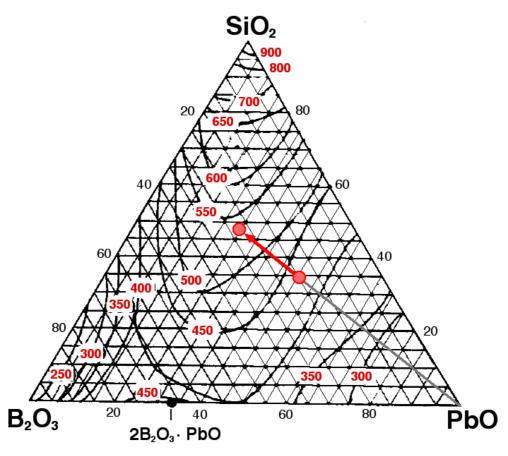


Fig. 6 Glass transition temperatures [11] in lead borosilicate glasses as a function of molar composition, with the starting and ending compositions of the glass in our dielectric.